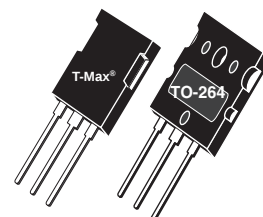


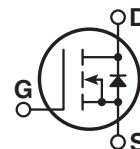


## Super Junction MOSFET

APT97N65B2C6



APT97N65LC6



- Ultra Low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Extreme  $dv/dt$  Rated

Unless stated otherwise, Microsemi discrete MOSFETs contain a single MOSFET die. This device is made with two parallel MOSFET die. It is intended for switch-mode operation. It is not suitable for linear mode operation.

### MAXIMUM RATINGS

All Ratings per die:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

| Symbol         | Parameter                                                                                             | APT97N65B2_LC6 | UNIT             |
|----------------|-------------------------------------------------------------------------------------------------------|----------------|------------------|
| $V_{DSS}$      | Drain-Source Voltage                                                                                  | 650            | Volts            |
| $I_D$          | Continuous Drain Current @ $T_C = 25^\circ\text{C}$ <sup>1</sup> (assuming $R_{DS(on)}$ max = 0.041Ω) | 97             | Amps             |
|                | Continuous Drain Current @ $T_C = 100^\circ\text{C}$                                                  | 62             |                  |
| $I_{DM}$       | Pulsed Drain Current <sup>2</sup>                                                                     | 291            |                  |
| $V_{GS}$       | Gate-Source Voltage Continuous                                                                        | ±20            | Volts            |
| $P_D$          | Total Power Dissipation @ $T_C = 25^\circ\text{C}$                                                    | 862            | Watts            |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range                                                      | -55 - to 150   | $^\circ\text{C}$ |
| $T_L$          | Lead Temperature: 0.063" from Case for 10 Sec.                                                        | 260            |                  |
| $I_{AR}$       | Avalanche Current <sup>2</sup>                                                                        | 13.4           | Amps             |
| $E_{AR}$       | Repetitive Avalanche Energy <sup>3</sup> ( $I_D = 13.4\text{A}$ , $V_{DD} = 50\text{V}$ )             | 2.96           |                  |
| $E_{AS}$       | Single Pulse Avalanche Energy ( $I_D = 13.4\text{A}$ , $V_{DD} = 50\text{V}$ )                        | 1954           | mJ               |

### STATIC ELECTRICAL CHARACTERISTICS

| Symbol       | Characteristic / Test Conditions                                                                              | MIN | TYP   | MAX   | UNIT          |
|--------------|---------------------------------------------------------------------------------------------------------------|-----|-------|-------|---------------|
| $BV_{(DSS)}$ | Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$ )                              | 650 |       |       | Volts         |
| $R_{DS(on)}$ | Drain-Source On-State Resistance <sup>4</sup> ( $V_{GS} = 10\text{V}$ , $I_D = 48.5\text{A}$ )                |     | 0.037 | 0.041 | Ohms          |
| $I_{DSS}$    | Zero Gate Voltage Drain Current ( $V_{DS} = 650\text{V}$ , $V_{GS} = 0\text{V}$ )                             |     |       | 25    | $\mu\text{A}$ |
|              | Zero Gate Voltage Drain Current ( $V_{DS} = 650\text{V}$ , $V_{GS} = 0\text{V}$ , $T_C = 150^\circ\text{C}$ ) |     |       | 250   |               |
| $I_{GSS}$    | Gate-Source Leakage Current ( $V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$ )                              |     |       | ±100  | nA            |
| $V_{GS(th)}$ | Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 2.96\text{mA}$ )                                          | 2.5 | 3     | 3.5   | Volts         |

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

# DYNAMIC CHARACTERISTICS

APT97N65B2\_LC6

| Symbol       | Characteristic                        | Test Conditions                                                                                                  | MIN | TYP  | MAX | UNIT |
|--------------|---------------------------------------|------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $C_{iss}$    | Input Capacitance                     | $V_{GS} = 0V$<br>$V_{DS} = 25V$<br>$f = 1\text{ MHz}$                                                            |     | 7650 |     | pF   |
| $C_{oss}$    | Output Capacitance                    |                                                                                                                  |     | 5045 |     |      |
| $C_{rss}$    | Reverse Transfer Capacitance          |                                                                                                                  |     | 550  |     |      |
| $Q_g$        | Total Gate Charge <sup>⑤</sup>        | $V_{GS} = 10V$<br>$V_{DD} = 325V$<br>$I_D = 97A @ 25^\circ C$                                                    |     | 300  |     | nC   |
| $Q_{gs}$     | Gate-Source Charge                    |                                                                                                                  |     | 50   |     |      |
| $Q_{gd}$     | Gate-Drain ("Miller") Charge          |                                                                                                                  |     | 160  |     |      |
| $t_{d(on)}$  | Turn-on Delay Time                    | <b>INDUCTIVE SWITCHING</b><br>$V_{GS} = 15V$<br>$V_{DD} = 433V$<br>$I_D = 97A @ 25^\circ C$<br>$R_G = 2.2\Omega$ |     | 25   |     | ns   |
| $t_r$        | Rise Time                             |                                                                                                                  |     | 60   |     |      |
| $t_{d(off)}$ | Turn-off Delay Time                   |                                                                                                                  |     | 275  |     |      |
| $t_f$        | Fall Time                             |                                                                                                                  |     | 130  |     |      |
| $E_{on}$     | Turn-on Switching Energy <sup>⑥</sup> | <b>INDUCTIVE SWITCHING @ 25°C</b><br>$V_{DD} = 433V, V_{GS} = 15V$<br>$I_D = 97A, R_G = 2.2\Omega$               |     | 2860 |     | μJ   |
| $E_{off}$    | Turn-off Switching Energy             |                                                                                                                  |     | 3500 |     |      |
| $E_{on}$     | Turn-on Switching Energy <sup>⑥</sup> | <b>INDUCTIVE SWITCHING @ 125°C</b><br>$V_{DD} = 433V, V_{GS} = 15V$<br>$I_D = 97A, R_G = 2.2\Omega$              |     | 4030 |     |      |
| $E_{off}$    | Turn-off Switching Energy             |                                                                                                                  |     | 3695 |     |      |

# SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol    | Characteristic / Test Conditions                                   | MIN                | TYP | MAX | UNIT  |
|-----------|--------------------------------------------------------------------|--------------------|-----|-----|-------|
| $I_S$     | Continuous Source Current (Body Diode)                             |                    |     | 97  | Amps  |
| $I_{SM}$  | Pulsed Source Current <sup>②</sup> (Body Diode)                    |                    |     | 291 |       |
| $V_{SD}$  | Diode Forward Voltage <sup>④</sup> ( $V_{GS} = 0V, I_S = -48.5A$ ) |                    | 0.9 | 1.2 | Volts |
| $dv/dt$   | Peak Diode Recovery <sup>dv/dt</sup> <sup>⑦</sup>                  |                    |     | 50  | V/ns  |
| $t_{rr}$  | Reverse Recovery Time<br>( $I_S = -97A, di/dt = 100A/\mu s$ )      | $T_J = 25^\circ C$ | 790 |     | ns    |
| $Q_{rr}$  | Reverse Recovery Charge<br>( $I_S = -97A, di/dt = 100A/\mu s$ )    | $T_J = 25^\circ C$ | 19  |     | μC    |
| $I_{RRM}$ | Peak Recovery Current<br>( $I_S = -97A, di/dt = 100A/\mu s$ )      | $T_J = 25^\circ C$ | 43  |     | Amps  |

# THERMAL CHARACTERISTICS

| Symbol          | Characteristic      | MIN | TYP | MAX   | UNIT |
|-----------------|---------------------|-----|-----|-------|------|
| $R_{\theta JC}$ | Junction to Case    |     |     | 0.145 | °C/W |
| $R_{\theta JA}$ | Junction to Ambient |     |     | 40    |      |

- Continuous current limited by package lead temperature.
  - Repetitive Rating: Pulse width limited by maximum junction temperature
  - Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV} = E_{AR} \cdot f$ . Pulse width tp limited by  $T_J$  max.
  - Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%
  - See MIL-STD-750 Method 3471
  - Eon includes diode reverse recovery.
  - Maximum 125°C diode commutation speed =  $di/dt$  600A/μs
- Microsemi reserves the right to change, without notice, the specifications and information contained herein.

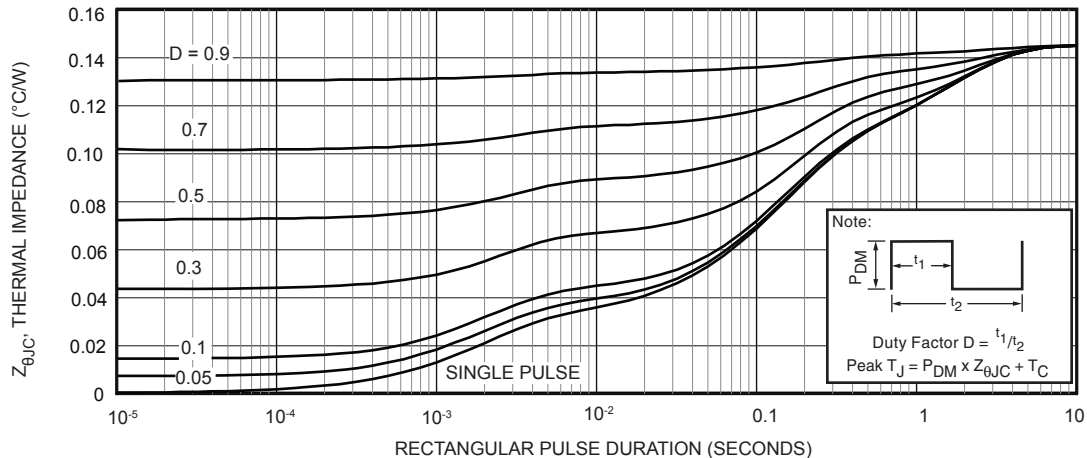


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

## Typical Performance Curves

APT97N65B2\_LC6

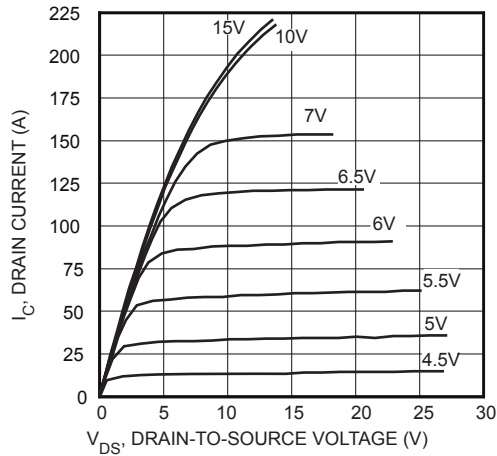


FIGURE 2, Low Voltage Output Characteristics

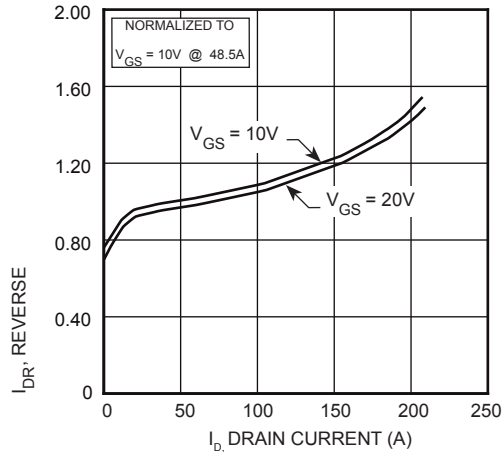


FIGURE 4,  $R_{DS(ON)}$  vs Drain Current

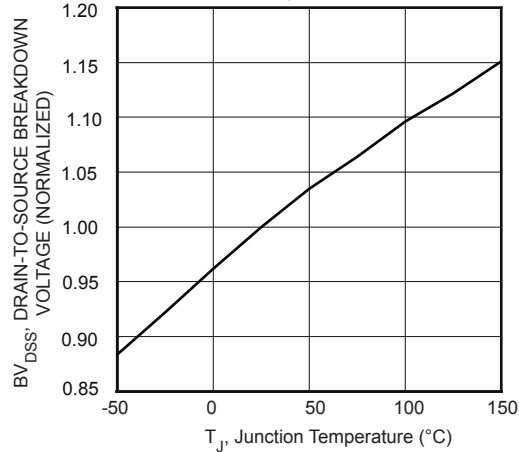


FIGURE 6, Breakdown Voltage vs Temperature

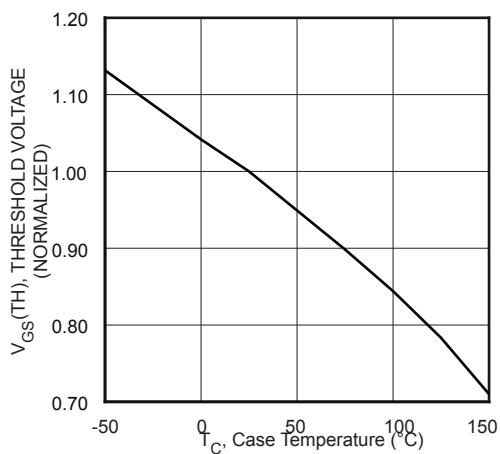


FIGURE 8, Threshold Voltage vs Temperature

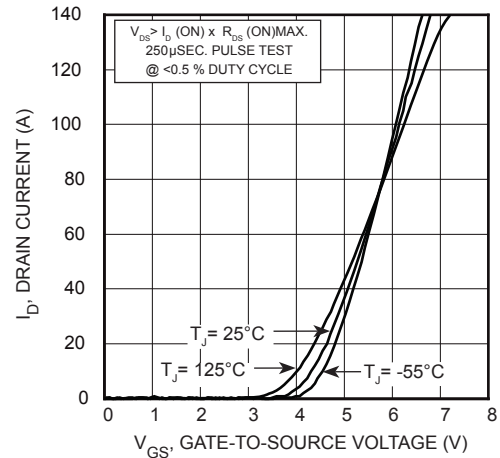


FIGURE 3, Transfer Characteristics

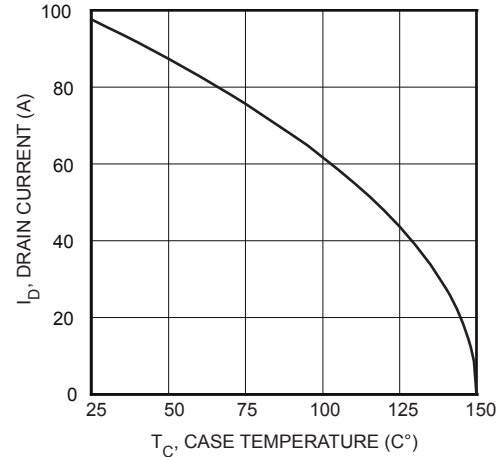


FIGURE 5, Maximum Drain Current vs Case Temperature

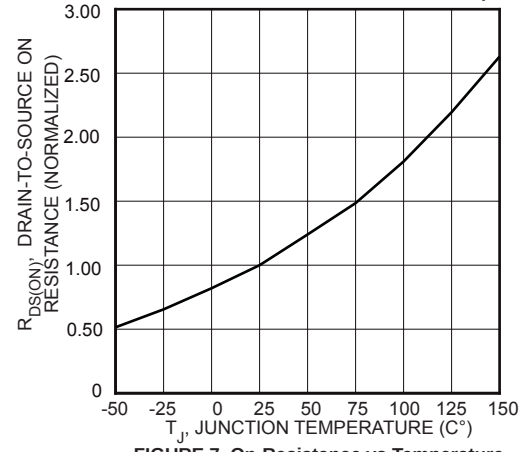


FIGURE 7, On-Resistance vs Temperature

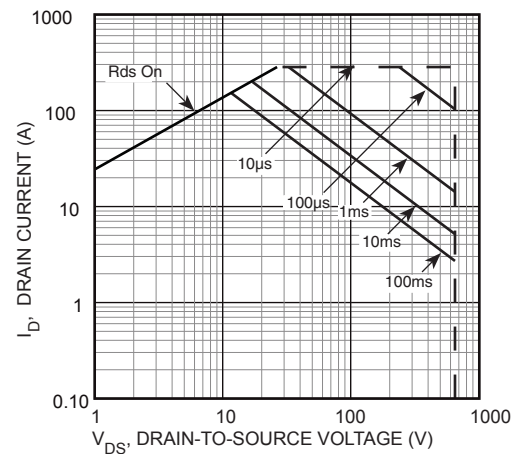


FIGURE 9, Maximum Safe Operating Area

# Typical Performance Curves

APT97N65B2\_LC6

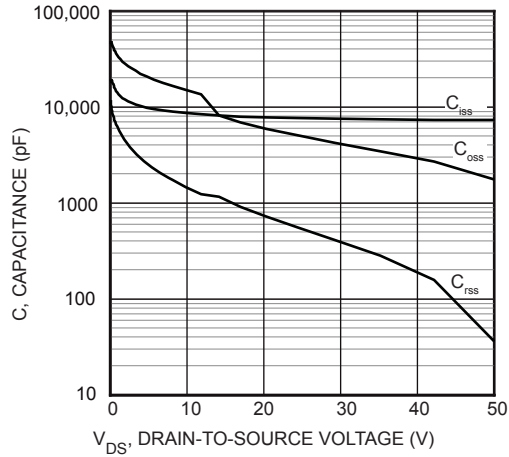


FIGURE 10, Capacitance vs Drain-To-Source Voltage

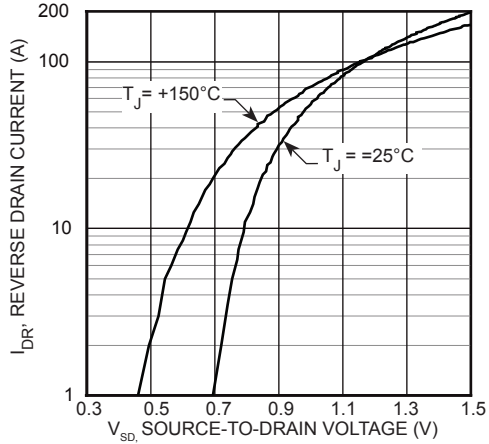


FIGURE 12, Source-Drain Diode Forward Voltage

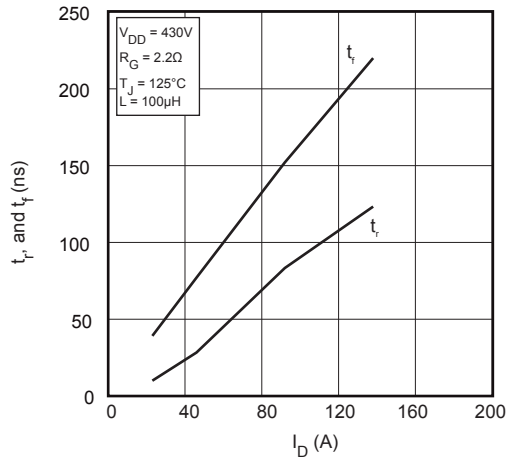


FIGURE 14, Rise and Fall Times vs Current

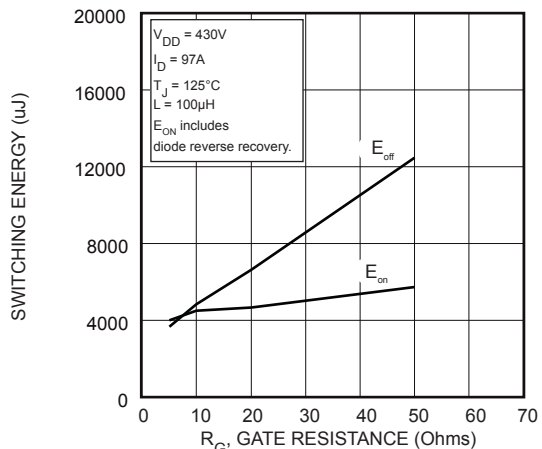


FIGURE 16, Switching Energy vs Gate Resistance

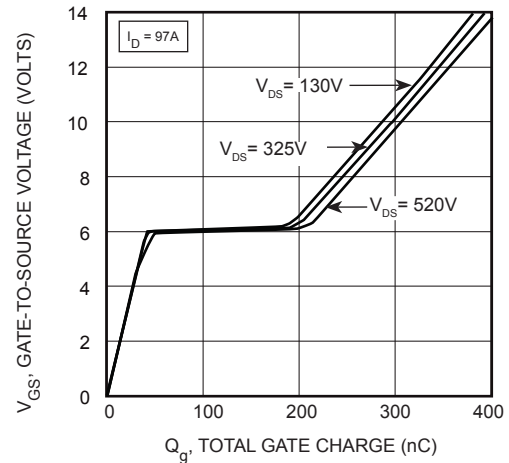


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

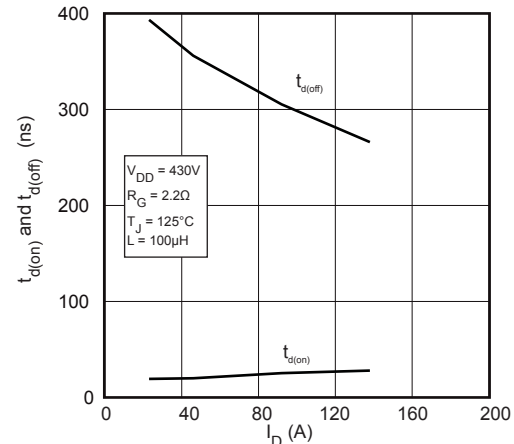


FIGURE 13, Delay Times vs Current

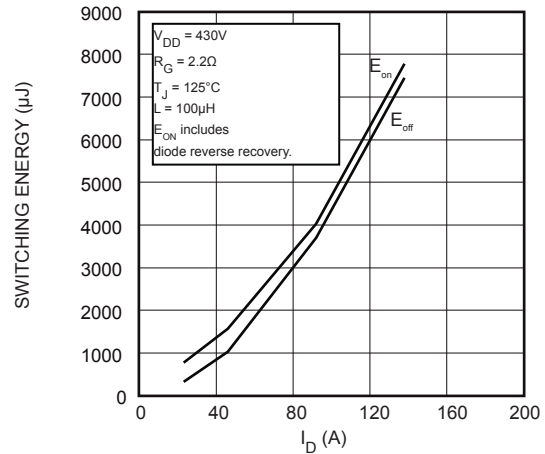


FIGURE 15, Switching Energy vs Current

## Typical Performance Curves

APT97N65B2\_LC6

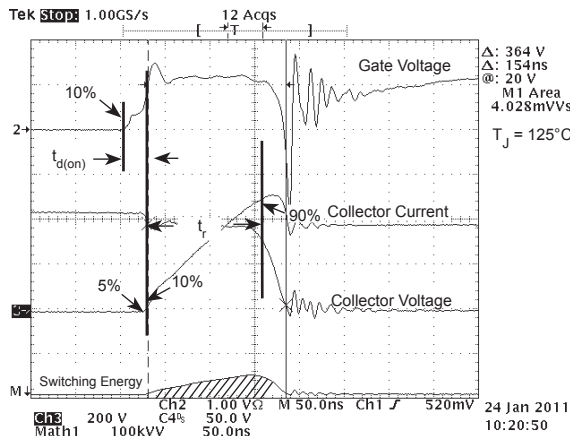


Figure 17, Turn-on Switching Waveforms and Definitions

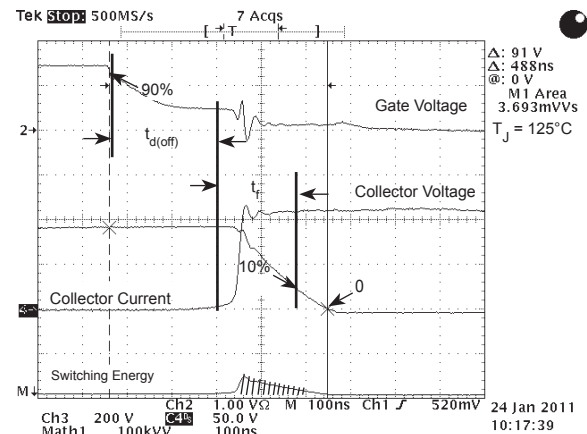


Figure 18, Turn-off Switching Waveforms and Definitions

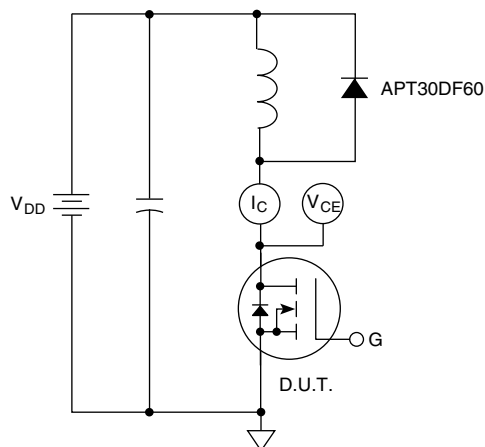
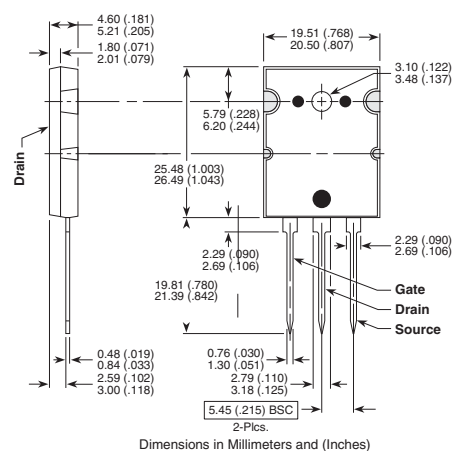
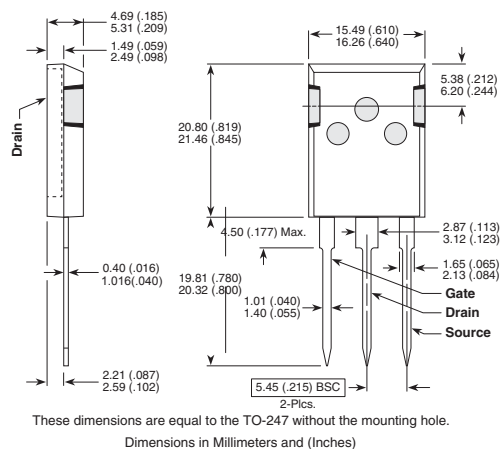


Figure 19, Inductive Switching Test Circuit

## T-MAX® (B2) Package Outline

## TO-264 (L) Package Outline

e3 100% Sn Plated



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